

STP40NF10

N-channel 100V - 0.025Ω - 50A TO-220 Low gate charge STripFET™ II Power MOSFET

General features

Туре	V _{DSS}	V _{DSS} R _{DS(on)}			
STP40NF10	100V	<0.028Ω	50A		

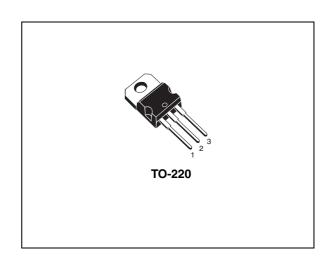
- Exceptional dv/dt capability
- Low gate charge at 100°C
- Application oriented characterization
- 100% avalanche tested

Description

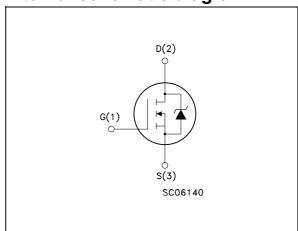
This MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STP40NF10	P40NF10	TO-220	Tube

Contents STP40NF10

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STP40NF10 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit		
V _{DS}	Drain-source voltage (v _{gs} = 0)	100	V		
V _{GS}	Gate- source voltage	±20	V		
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C	50	Α		
I _D	Drain current (continuous) at T _C = 100°C	ntinuous) at T _C = 100°C 35			
I _{DM} ⁽²⁾	Drain current (pulsed)	200	Α		
P _{TOT}	Total dissipation at T _C = 25°C	150	W		
	Derating factor	1			
dv/dt ⁽³⁾	Peak diode recovery voltage slope	27			
E _{AS} (4)	Single pulse avalanche energy	pulse avalanche energy 385			
T _{stg}	Storage temperature				
Tj	Max. operating junction temperature	- 55 to 175			

- 1. Limited by wire bonding
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \leq 50A$, di/dt $\leq 600A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_j \leq T_{JMAX}$.
- 4. Starting T_i = 25°C, I_D = 50A, V_{DD} =25V

Table 2. Thermal data

R _{thj-case}	Thermal resistance junction-case Max	1	°C/W
R _{thj-a}	Thermal resistance junction-ambient Max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Electrical characteristics STP40NF10

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	100			٧
	Zero gate voltage	V _{DS} = Max rating			1	μΑ
I _{DSS}	Drain current (V _{GS} = 0)	V _{DS} =Max rating,T _C =125°C			10	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	٧
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 25A		0.025	0.028	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V _, I _D =28A		22		S
C _{iss}	Input capacitance			2180		pF
C _{oss}	Output capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		298		pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$		83.7		pF
Qg	Total gate charge	$V_{DD} = 80V, I_{D} = 50A,$		57.6	76	nC
Q_{gs}	Gate-source charge	$V_{DD} = 80V, I_D = 50A,$ $V_{GS} = 10V$		13.3		nC
Q_{gd}	Gate-drain charge	(see Figure 14)		17.5		nC

^{1.} Pulsed: Pulse duration = 300 µs, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	$V_{DD} = 50$ V, $I_D = 25$ A $R_G = 4.7\Omega V_{GS} = 10$ V (see Figure 13)		21 46		ns ns
t _{d(off)}	Turn-off-delay time Fall time	V_{DD} = 27V, I_D = 40A, R_G = 4.7 Ω , V_{GS} = 10V (see Figure 13)		54 13		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current				80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				320	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 50A, V_{GS} = 0$			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 50A, V_{DD} = 25V di/dt = 100A/ μ s, T_j = 150°C (see Figure 15)		80 250 6.4		ns nC A

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STP40NF10

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

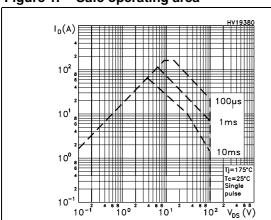


Figure 2. Thermal impedance

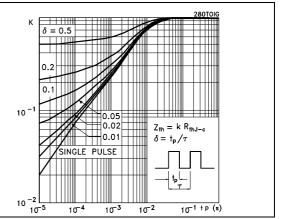


Figure 3. Output characteristics

Figure 4. Transfer characteristics

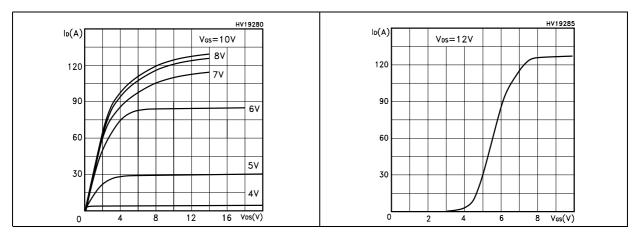


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

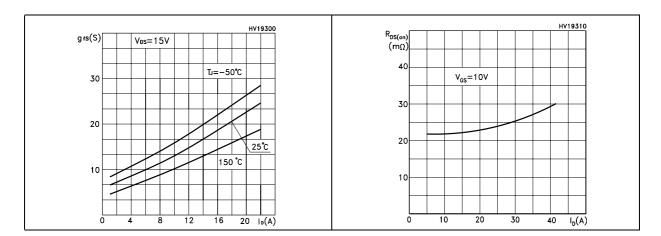


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

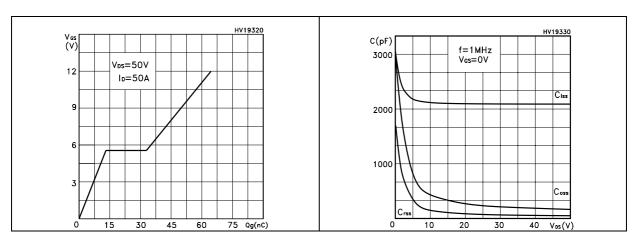


Figure 9. Normalized gate threshold voltage vs. temperature

Figure 10. Normalized on resistance vs. temperature

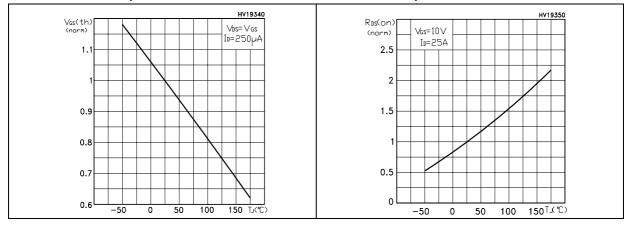
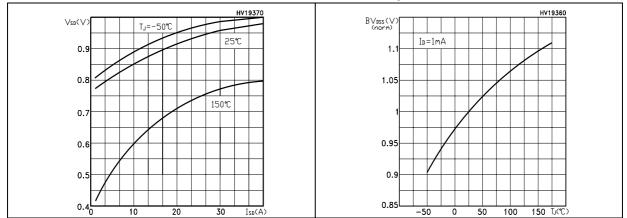


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs. tj



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Test circuit STP40NF10

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

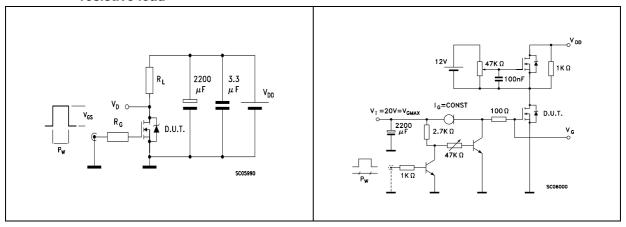


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

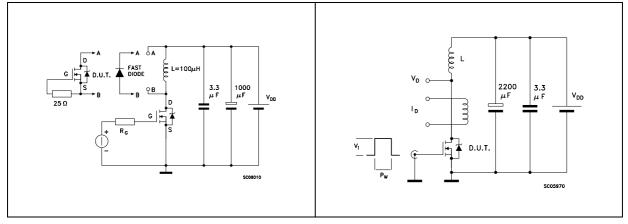
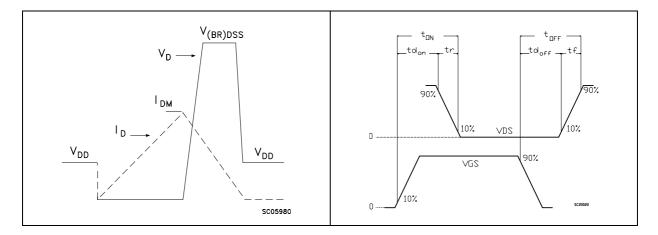


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

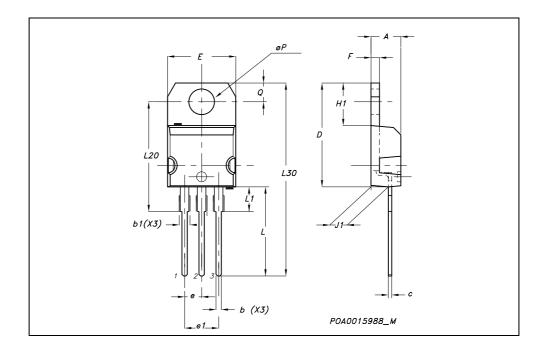


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220 MECHANICAL DATA

DIM.		mm.			inch	
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
Е	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



STP40NF10 Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes	
16-Dec-2004	1	First version.	
17-Aug-2006	2	The document has been reformatted.	
31-Jan-2007	3	Typo mistake on <i>Table 1</i> .	

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